

Brookfield, CT; and DuPont Photomasks, Inc., Austin, TX. The nature and objectives of the venture are to develop and demonstrate an intelligent mask inspection system for next generation lithography for use in the semiconductor industry.

**Constance K. Robinson,**

*Director of Operations, Antitrust Division.*  
[FR Doc. 99-3921 Filed 2-17-99; 8:45 am]  
BILLING CODE 4410-11-M

## DEPARTMENT OF JUSTICE

### Antitrust Division

#### Notice Pursuant to the National Cooperative Research and Production Act of 1993—Microelectronics and Computers Technology Corporation ("MCC")

Notice is hereby given that, on March 18, 1998, pursuant to Section 6(a) of the National Cooperative Research and Production Act of 1993, 15 U.S.C. 4301 *et seq.* ("the Act"), Microelectronics and Computer Technology Corporation ("MCC") has filed written notifications simultaneously with the Attorney General and the Federal Trade Commission disclosing changes in its status. The notifications were filed for the purpose of extending the Act's provisions limiting the recovery of antitrust plaintiffs to actual damages under specified circumstances. Specifically, Texas Instruments, Dallas, TX, has become an MCC shareholder. The Boeing Company, Seattle, WA; Hughes Research Lab (HRL, L.L.C.), Malibu, CA; and Hughes Electronics, El Segundo, CA have become associate members. Raytheon, Lexington, MA, recently acquired the Hughes Aircraft Company portion of GM Hughes and will become the MCC shareholder. SAIC, San Diego, CA, recently merged with Bellcore and is in the process of obtaining Bellcore's share and will become the MCC shareholder. Ceridian Corporation has transferred its MCC share to General Dynamics, Falls Church, VA. BBN Corporation, Pacific Sierra Research Corporation, Eastman Chemical Company and Nationsbank have declined to rejoin MCC. Schlumberger, San Jose, CA; and VLSI, San Jose, CA are being listed as 1998 project participants.

Lucent, 3M, Nokia, Nortel, Intel, Motorola and Hewlett-Packard have joined the Loc Cost Portables Project. Raytheon and Schlumberger have joined the Infosluth II Project. Honeywell has joined the Quest Project. Motorola and Nokia have joined the ProReal Visual Prototyping Project. Raytheon has

joined the Object Infrastructure Project. VLSI Technology has joined the Server and Network Technology Project.

No other changes have been made in either the membership or planned activity of the group research project. Membership in this group research project remains open, and intends to file additional written notification disclosing all change in membership.

On December 21, 1984, MCC filed its original notification pursuant to Section 6(a) of the Act. The Department of Justice published a notice in the **Federal Register** pursuant to Section 6(b) of the Act on January 17, 1985 (50 FR 2633).

The last notification was filed with the Department on October 8, 1997. A notice was published in the **Federal Register** pursuant to Section 6(b) of the Act on April 8, 1998 (63 FR 17214).

**Constance K. Robinson,**

*Director of Operations, Antitrust Division.*  
[FR Doc. 99-3919 Filed 2-17-99; 8:45 am]  
BILLING CODE 4410-11-M

## DEPARTMENT OF JUSTICE

### Antitrust Division

#### Notice Pursuant to the National Cooperative Research and Production Act of 1993—National Semiconductor Corporation

Notice is hereby given that, on October 22, 1998, pursuant to Section 6(a) of the National Cooperative Research and Production Act of 1993, 15 U.S.C. 4301 *et seq.* ("the Act"), National Semiconductor Corporation has filed written notifications simultaneously with the Attorney General and the Federal Trade Commission disclosing (1) the identities of the parties and (2) the nature and objectives of the venture. The notifications were filed for the purpose of invoking the Act's provisions limiting the recovery of antitrust plaintiffs to actual damages under specified circumstances. Pursuant to Section 6(b) of the Act, the identities of the parties are National Semiconductor Corporation, Santa Clara, CA; FSI International Corporation, Allen, TX; KLA-Tencor Corporation, San Jose, CA; Lam Research Corporation, Fremont, CA; The Board of Trustees of Leland Stanford Junior University, Stanford, CA; and University of Michigan, Ann Arbor, MI. The nature and objectives of the venture are to develop technology to intelligently control the semiconductor patterning process.

The activities of this joint venture will be partially funded by an award from the Advanced Technology Program,

National Institute of Standards and Technology, Department of Commerce.

**Constance K. Robinson,**

*Director of Operations, Antitrust Division.*  
[FR Doc. 99-3924 Filed 2-17-99; 8:45 am]  
BILLING CODE 4410-11-M

## DEPARTMENT OF JUSTICE

### Antitrust Division

#### Notice Pursuant to the National Cooperative Research and Production Act of 1993—Semi/Sematech Chapter, Inc. ("Semi/Sematech")

Notice is hereby given that, on October 7, 1998, pursuant to Section 6(a) of the National Cooperative Research and Production Act of 1993, 15 U.S.C. 4301 *et seq.* ("the Act"), SEMI/SEMATECH CHAPTER, INC. ("SEMI/SEMATECH") has filed written notifications simultaneously with the Attorney General and the Federal Trade Commission disclosing (1) the identities of the parties, and (2) the nature and objectives of the venture. The notifications were filed for the purpose of invoking the Act's provisions limiting the recovery of antitrust plaintiffs to actual damages under specified circumstances. Pursuant to Section 6(b) of the Act, the identities of the parties are 3M Company, Austin, TX; Acorn Engineering & Consulting, Tucson, AZ; ADE Corporation, Westwood, MA; Advanced Energy Industries, Inc., Fort Collins, CO; Advanced Materials Instruments and Analysis, Inc., Austin, TX; Advanced Technology Materials, Inc. (ATMI), Danbury, CT; Aeroquip Corporation, Maumee, OH; AG Associates, San Jose, CA; AGI, Abbie Gregg, Inc., Tempe, AZ; Air Products and Chemicals, Allentown, PA; AMOCO Electronic Materials Venture, Naperville, IL; Applied Materials, Santa Clara, CA; Applied Process Technology, Inc., Redwood Shores, CA; Applied Science and Technology, Inc., Woburn, MA; Ashland Chemical Company, Dublin, OH; Asyst Technologies, Inc., Fremont, CA; Bio-Rad Semiconductor Systems, Mountain View, CA; Boxer Cross, Inc., Menlo Park, CA; Brewer Science, Inc., Rolla, MO; Brooks Automation, Chelmsford, MA; Brooks Instrument, Hatfield, PA; Brookside Software, Inc., San Carlos, CA; Cadence Design Systems, Inc., San Jose, CA; Calgon Carbon Corporation, Pittsburgh, PA; Cascade Separations, Inc., Houston, TX; CFD Research Corporation, Huntsville, AL; CFM Technologies, Inc., West Chester, PA; Chapman Instruments, Rochester, NY; Charles Evans & Associates, Redwood City, CA;

Coastal Instrument & Electronics, Burgaw, NC; Comdel, Inc., Gloucester, MA; Credence Systems Corporation, Fremont, CA; CTI-Cryogenics, Mansfield, MA; CVC, Inc., Rochester, NY; Cymer, Inc., San Diego, CA; Digital Instruments, Santa Barbara, CA; Dow Chemical Company, Midland, MI; Dow Corning Corporation, Auburn, MI; Dryden Engineering Company, Inc., Fremont, CA; Duke Scientific Corporation, Palo Alto, CA; Dupont Photomasks, Wilmington, DE; DYM, Inc., Bedford, MA; Dynatronix, Inc., Amery, WI; E.O.R.M., Inc., Sunnyvale, CA; Eaton Corporation, Beverly, MA; EG&G Aerospace & Engineered Products, Beltsville MD; Electroglas, Inc., Santa Clara, CA; Emcore Corporation, Somerset, NJ; ENI, Rochester, NY; ETEC Systems, Inc., Hayward, CA; Extraction Systems, Inc., Franklin, MA; Flip Chip Technologies LLC, Phoenix, AZ; Fluent, Inc., Lebanon, NH; Fortrend Engineering Corporation, Sunnyvale, CA; Fourth State Technology, Austin, TX; FSI International, Chaska, MN; Furon Company, Laguna Niguel, CA; GaSonics International, San Jose, CA; GW Associates, Inc., Sunnyvale, CA; HPG International, Inc., Somerset, NJ; HUNTAIR, Tigard, OR; Industrial Design Corporation (IDC), Portland, OR; Insync Systems, Inc., Milpitas, CA; Integrated Flow Systems, Inc., Scotts Valley, CA; Interface Systems, DE, Inc., Gladwyne, PA; Ion Systems, Berkeley, CA; IPEC, Phoenix, AZ; Keithley Instruments, Inc., Cleveland, OH; KLA-Tencor, San Jose, CA; KLA-Tencor Amray Division, Bedford, MA; Kulicke & Soffa Industries, Inc., Willow Grove, PA; Lam Research Corporation, Fremont, CA; Lambda Physik, Inc., Ft. Lauderdale, FL; Lambda Technologies, Inc., Morrisville, NC; Lucid Treatment Systems, Hollister, CA; Manugistics, Los Altos, CA; MEECO, Inc., Warrington, PA; Mentor Graphics Corporation, Wilsonville, OR; Metal Fab Corporation, Ormond Beach, FL; Micrion Corporation, Peabody, MA; Microbar, Inc., Sunnyvale, CA; MicroFab Technologies, Inc., Plano, TX; Millipore Corporation, Bedford, MA; MKS Instruments, Inc., Andover, MA; Mott Metallurgical Corporation, Farmington, CT; Nalco Chemical Company, Naperville, IL; Nanometrics Incorporated, Sunnyvale, CA; Novellus Systems, Inc., San Jose, CA; NTA Industries, Inc., Milpitas, CA; ObjectSpace, Inc., Austin, TX; Obsidian, Fremont, CA; Olin Corporation, Norwalk, CT; OPC Technology, Inc., San Jose, CA; Pacific Scientific Company, Newport Beach, CA; Pall Corporation,

Glen Cove, NY; Parker Hannifin Corporation, Lebanon, IN; PCT Systems, Inc., Fremont, CA; Photronics, Inc., Brookfield, CT; Physical Electronics, Inc., Eden Prairie, MN; Praxair, Inc., Danbury, CT; Precise Sensors, Inc., Monrovia, CA; PRI Automation, Billerica, MA; Process Specialities, Tracy, CA; Progressive Technologies, Inc., Tewksbury, MA; Pyromatics, Inc., Willoughby, OH; QC Optics, Inc., Wilmington, MA; Radian International, Austin, TX; Research Electro-Optics, Inc., Boulder, CO; Reynolds Tech Fabricators, Inc., East Syracuse, NY; RF Power Products, Voorhees, NJ; RF Services, Inc., Sunnyvale, CA; Rippey Corporation, El Dorado Hills, CA; Rudolph Technologies, Flanders, NJ; SACHEM, Inc., Austin, TX; SCP Global Technologies, Boise, ID; Semifab Incorporated, Hollister, CA; Semitest, Inc., Billerica, MA; Semitool Incorporated, Kalispell, MT; SEMY Engineering, Inc., Phoenix, AZ; SensArray Corporation, Santa Clara, CA; Sensys Instruments Corporation, Sunnyvale, CA; Shipley Company, Inc., Marlborough, MA; Shuttleworth, Inc., Huntington, IN; S12 (Silicon Integration Initiative, Inc.), Austin, TX; Sievers Instruments, Boulder, CO; Silicon Valley Group, Inc., San Jose, CA; Solid State Equipment Corporation, Horsham, PA; Solid State Measurements, Inc., Pittsburgh, PA; Southwest Research Institute, San Antonio, TX; Speedfam Corporation, Des Plaines, IL; Stellar Dynamics, Boise, ID; Strasbaugh, San Luis Obispo, CA; SubMicron Systems Corporation, Allentown, PA; Superior Design, Inc., Peabody, MA; Suss Advanced Lithography, Inc., South Burlington, VT; Swagelok Marketing Co., Solon, OH; Syncro Vac, Elgin, TX; Synopsis, Mountain View, CA; Systematic Designs International, Inc., Vancouver, WA; TDIndustries—Technology Group, Dallas, TX; Tegal Corporation, Petaluma, CA; Teradyne, Inc., Boston, MA; Tescom Corporation, Elk River, MN; Therma-Wave, Inc., Fremont, CA; Thomas West, Inc., Sunnyvale, CA; TRW, McLean, VA; TSI Field Service, Inc., Albuquerque, NM; Ultrapointe Corporation, San Jose, CA; Ultratech Stepper, Inc., San Jose, CA; Unit Instruments, Inc., Yorba Linda, CA; Varian, Palo Alto, CA; Veeco Instruments, Plainview, NY; Veriflo Corporation, Richmond, CA; Veriteq, Inc., Santa Ana, CA; W.L. Gore & Associates, Inc., Elkton, MD; Watkins-Johnson Company, Scotts Valley, CA; Westlake Plastics Company, Lenni, PA; Wright Williams & Kelly, Inc., Pleasanton, CA; and Zygo Advanced Imaging Systems, San Francisco, CA.

The nature and objectives of the venture are to promote the research and development of advanced semiconductor manufacturing techniques, to further the common business interests and technology growth of the U.S. Semiconductor equipment and materials industries and to facilitate collaboration throughout the semiconductor supply chain to enable SEMI/SEMATECH members to be the leading suppliers to the global semiconductor industry.

**Constance K. Robinson,**

*Director of Operations, Antitrust Division.*

[FR Doc. 99-3916 Filed 2-17-99; 8:45 am]

BILLING CODE 4410-11-M

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## DEPARTMENT OF LABOR

### Employment and Training Administration

#### Investigations Regarding Certifications of Eligibility to Apply for Worker Adjustment Assistance

Petitions have been filed with the Secretary of Labor under Section 221(a) of the Trade Act of 1974 ("the Act") and are identified in the Appendix to this notice. Upon receipt of these petitions, the Acting Director of the Office of Trade Adjustment Assistance, Employment and Training Administration, has instituted investigations pursuant to Section 221(a) of the Act.

The purpose of each of the investigations is to determine whether the workers are eligible to apply for adjustment assistance under Title II, Chapter 2, of the Act. The investigations will further relate, as appropriate, to the determination of the date on which total or partial separations began or threatened to begin and the subdivision of the firm involved.

The petitioners or any other persons showing a substantial interest in the subject matter of the investigations may request a public hearing, provided such request is filed in writing with the Acting Director, Office of Trade Adjustment Assistance, at the address shown below, not later than March 1, 1999.

Interested persons are invited to submit written comments regarding the subject matter of the investigations to the Acting Director, Office of Trade Adjustment Assistance, at the address shown below, not later than March 1, 1999.

The petitions filed in this case are available for inspection at the Office of the Acting Director, Office of Trade Adjustment Assistance, Employment